

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[NVE Corporation](#)

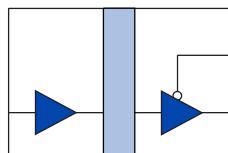
[IL814TE](#)

For any questions, you can email us directly:

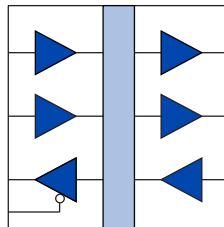
sales@integrated-circuit.com

DC-Correct High Speed Digital Isolators

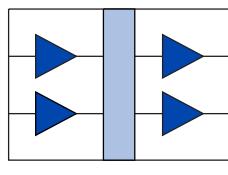
Functional Diagrams



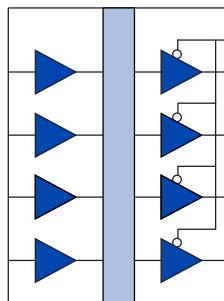
IL810



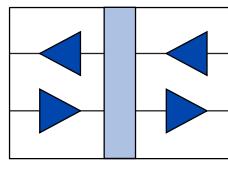
IL814



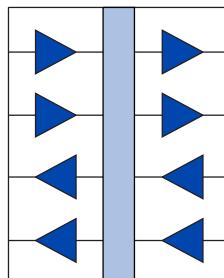
IL811



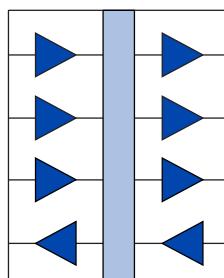
IL815



IL821



IL816



IL817

Features

- DC-correct
- -40°C to 125°C operating temperature
- 110 Mbps
- 10 ns propagation delay
- 1.3 mA/channel typical quiescent current
- 50 kV/ μs typ.; 30 kV/ μs min. common mode transient immunity
- 600 V_{RMS} working voltage per VDE 0884
- 44000 year barrier life
- 3 V to 5 V power supplies
- Low EMC footprint
- 8-pin MSOP and SOIC packages for one and two channels
- 16-pin QSOP, 0.15" SOIC, and 0.3" True 8™ SOIC for 3 and 4 channels
- IEC 60747-5-5 (VDE 0884) certified; UL 1577 recognized

Applications

- ADCs and DACs
- Digital Fieldbus
- RS-485 and RS-422
- Multiplexed data transmission
- Data interfaces
- Board-to-board communication
- Digital noise reduction
- Ground loop elimination
- Peripheral interfaces
- Parallel bus
- Logic level shifting

Description

IL800-Series isolators are high-speed, high temperature dc-correct isolators. An internal refresh clock ensures the outputs respond to dc states on inputs within a maximum of 9 μs .

The devices use NVE's patented* IsoLoop® spintronic Giant Magnetoresistive (GMR) technology.

A unique ceramic/polymer composite barrier provides excellent isolation and virtually unlimited barrier life.

Absolute Maximum Ratings⁽¹⁾

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Storage Temperature	T_S	-55		150	°C	
Ambient Operating Temperature	T_A	-40		125	°C	
Supply Voltage	V_{DD1}, V_{DD2}	-0.5		7	V	
Input Voltage	V_I	-0.5		$V_{DD}+0.5$	V	
Output Voltage	V_O	-0.5		$V_{DD}+0.5$	V	
Output Current Drive	I_O			10	mA	
Lead Solder Temperature				260	°C	10 sec.
ESD			2		kV	HBM

Recommended Operating Conditions

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Ambient Operating Temperature	T_A	-40		125	°C	
Supply Voltage	V_{DD1}, V_{DD2}	3.0		5.5	V	
Logic High Input Voltage	V_{IH}	2.4		V_{DD}	V	
Logic Low Input Voltage	V_{IL}	0		0.8	V	
Input Signal Rise and Fall Times ⁽¹⁰⁾	t_{IR}, t_{IF}		DC-Correct			

Insulation Specifications

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Creepage Distance (external)	MSOP QSOP 0.15" SOIC (8 or 16 pin) 0.3" SOIC	3.0 4.03 4.03 8.03		8.3	mm	Per IEC 60601
Total Barrier Thickness (internal)		0.012	0.013		mm	
Leakage Current			0.2		µA	240 V _{RMS} , 60 Hz
Barrier Resistance	R_{IO}		$>10^{14}$		Ω	500 V
Barrier Capacitance	C_{IO}		4		pF	f = 1 MHz
Comparative Tracking Index	CTI	≥ 175			V	Per IEC 60112
High Voltage Endurance (Maximum Barrier Voltage for Indefinite Life)	AC DC	V_{IO}	1000 1500		V_{RMS} V_{DC}	At maximum operating temperature
Barrier Life			44000		Years	100°C, 1000 V _{RMS} , 60% CL activation energy

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Junction–Ambient Thermal Resistance	QSOP 0.15" SOIC 0.3" SOIC	θ_{JA}	60 60 60		°C/W	
Junction–Case (Top) Thermal Resistance	QSOP 0.15" SOIC 0.3" SOIC	Ψ_{JT}	10 10 20		°C/W	Soldered to double-sided board; free air
Power Dissipation	QSOP 0.15" SOIC 0.3" SOIC	P_D		675 700 800	mW	



IL800-Series Isolators

Safety and Approvals

IEC 60747-5-5 (VDE 0884) (File Number 5016933-4880-0001)

- Working Voltage (V_{IORM}) 600 V_{RMS} (848 V_{PK}); basic insulation; pollution degree 2
- Transient overvoltage (V_{IOTM}) and surge voltage (V_{IOSM}) 4000 V_{PK}
- Each part tested at 1590 V_{PK} for 1 second, 5 pC partial discharge limit
- Samples tested at 4000 V_{PK} for 60 sec.; then 1358 V_{PK} for 10 sec. with 5 pC partial discharge limit

IEC 61010-1 (Edition 2; TUV Certificate Numbers N1502812; N1502812-101)

Reinforced Insulation; Pollution Degree II; Material Group III

Part No. Suffix	Package	Working Voltage
-1	MSOP/QSOP	150 V _{RMS}
-3	SOIC	150 V _{RMS}
None	Wide-body SOIC/True 8™	300 V _{RMS}

UL 1577 (Component Recognition Program File Number E207481)

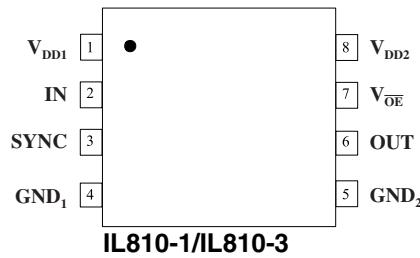
Each part tested at 3000 V_{RMS} (4240 V_{PK}) for 1 second; each lot sample tested at 2500 V_{RMS} (3530 V_{PK}) for 1 minute

Soldering Profile

Per JEDEC J-STD-020C, MSL 1

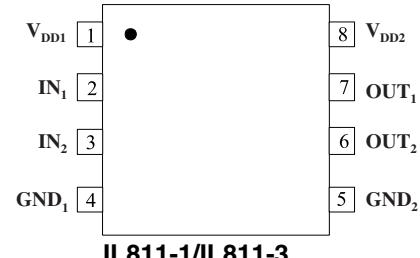
IL810-1/IL810-3 Pin Connections

1	V _{DD1}	Supply voltage
2	IN	Data in
3	SYNC	Internal refresh clock disable (normally enabled and internally held low with 10 kΩ)
4	GND ₁	Ground return for V _{DD1}
5	GND ₂	Ground return for V _{DD2}
6	OUT	Data out
7	V _{OE}	Output enable (internally held low with 100 kΩ)
8	V _{DD2}	Supply voltage



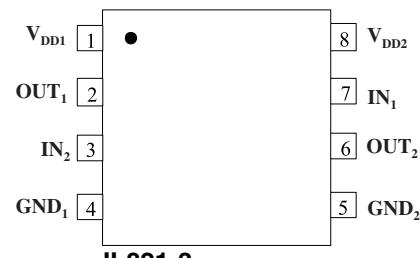
IL811-1/IL811-3 Pin Connections

1	V _{DD1}	Supply voltage
2	IN ₁	Data in, channel 1
3	IN ₂	Data in, channel 2
4	GND ₁	Ground return for V _{DD1}
5	GND ₂	Ground return for V _{DD2}
6	OUT ₂	Data out, channel 2
7	OUT ₁	Data out, channel 1
8	V _{DD2}	Supply voltage



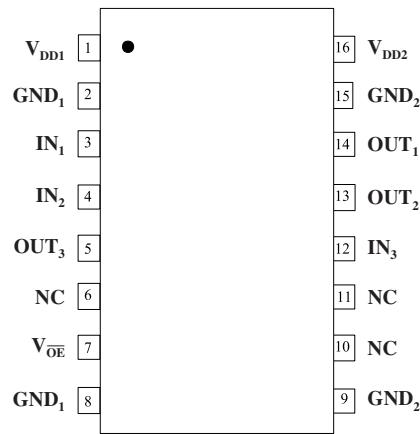
IL821-3 Pin Connections

1	V _{DD1}	Supply voltage
2	OUT ₁	Data out, channel 1
3	IN ₂	Data in, channel 2
4	GND ₁	Ground return for V _{DD1}
5	GND ₂	Ground return for V _{DD2}
6	OUT ₂	Data out, channel 2
7	IN ₁	Data in, channel 1
8	V _{DD2}	Supply voltage



IL814-1/IL814-3/IL814 Pin Connections

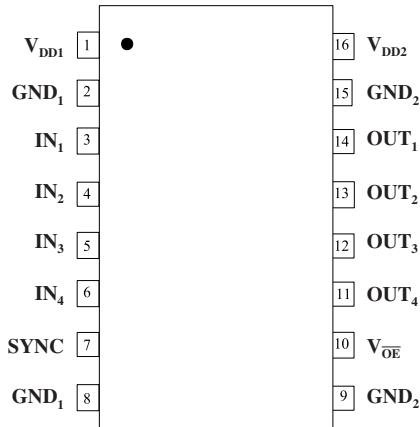
1	V _{DD1}	Supply voltage 1
2	GND ₁	Ground return for V _{DD1} (pin 2 internally connected to pin 8)
3	IN ₁	Data in, channel 1
4	IN ₂	Data in, channel 2
5	OUT ₃	Data out, channel 3
6	NC	No connection
7	V _{OE}	Output enable, channel 3 (internally held low with 100 kΩ)
8	GND ₁	Ground return for V _{DD1} (pin 8 internally connected to pin 2)
9	GND ₂	Ground return for V _{DD2} (pin 9 internally connected to pin 15)
10	NC	No connection
11	NC	No connection
12	IN ₃	Data in, channel 3
13	OUT ₂	Data out, channel 2
14	OUT ₁	Data out, channel 1
15	GND ₂	Ground return for V _{DD2} (pin 15 internally connected to pin 9)
16	V _{DD2}	Supply voltage



IL814-1/IL814-3/IL814

IL815-1/IL815-3/IL815 Pin Connections

1	V _{DD1}	Supply voltage
2	GND ₁	Ground return for V _{DD1} (pin 2 internally connected to pin 8)
3	IN ₁	Data in, channel 1
4	IN ₂	Data in, channel 2
5	IN ₃	Data in, channel 3
6	IN ₄	Data in, channel 4
7	SYNC*	Internal refresh clock disable (normally enabled and internally held low with 10 kΩ)
8	GND ₁	Ground return for V _{DD1} (pin 8 internally connected to pin 2)
9	GND ₂	Ground return for V _{DD2} (pin 9 internally connected to pin 15)
10	V _{OE} *	Output enable for all outputs (internally held low with 100 kΩ)
11	OUT ₄	Data out, channel 4
12	OUT ₃	Data out, channel 3
13	OUT ₂	Data out, channel 2
14	OUT ₁	Data out, channel 1
15	GND ₂	Ground return for V _{DD2} (pin 15 internally connected to pin 9)
16	V _{DD2}	Supply voltage



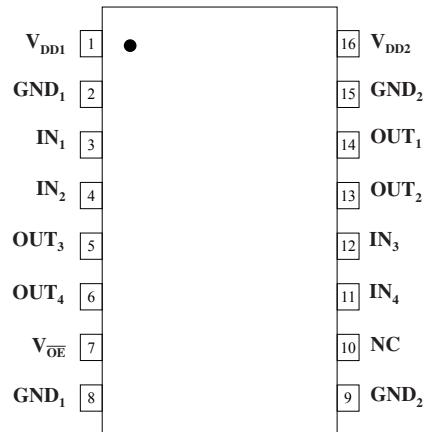
IL815-1/IL815-3/IL815

*Wide-body version (IL815TE) only.

No internal connections to pins 7 or 10
in QSOP or narrow-body (IL815T-1E or IL815T-3E) versions.

IL816-1/IL816-3/IL816 Pin Connections

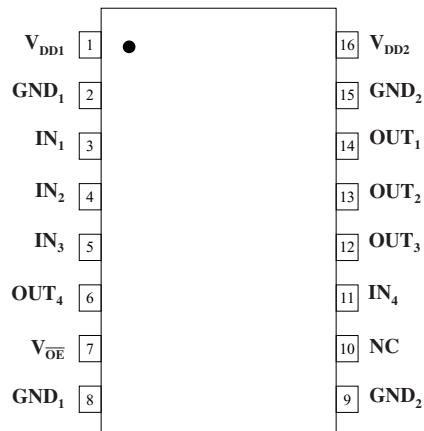
1	V _{DD1}	Supply voltage
2	GND ₁	Ground return for V _{DD1} (pin 2 internally connected to pin 8)
3	IN ₁	Data in, channel 1
4	IN ₂	Data in, channel 2
5	OUT ₃	Data out, channel 3
6	OUT ₄	Data out, channel 4
7	V _{OE}	Output enable, channels 3 and 4 (internally held low with 100 kΩ)
8	GND ₁	Ground return for V _{DD1} (pin 8 internally connected to pin 2)
9	GND ₂	Ground return for V _{DD2} (pin 9 internally connected to pin 15)
10	NC	No connection
11	IN ₄	Data in, channel 4
12	IN ₃	Data in, channel 3
13	OUT ₂	Data out, channel 2
14	OUT ₁	Data out, channel 1
15	GND ₂	Ground return for V _{DD2} (pin 15 internally connected to pin 9)
16	V _{DD2}	Supply voltage



IL816-1/IL816-3/IL816

IL817-3/IL817 Pin Connections

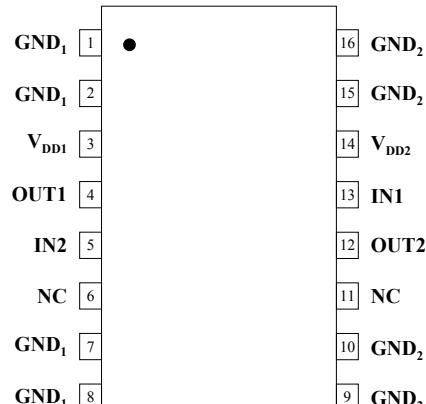
1	V _{DD1}	Supply voltage
2	GND ₁	Ground return for V _{DD1} (pin 2 internally connected to pin 8)
3	IN ₁	Data in, channel 1
4	IN ₂	Data in, channel 2
5	IN ₃	Data in, channel 3
6	OUT ₄	Data out, channel 4
7	V _{OE}	Output enable, channel 4 (internally held low with 100 kΩ)
8	GND ₁	Ground return for V _{DD1} (pin 8 internally connected to pin 2)
9	GND ₂	Ground return for V _{DD2} (pin 9 internally connected to pin 15)
10	NC	No connection
11	IN ₄	Data in, channel 4
12	OUT ₃	Data out, channel 3
13	OUT ₂	Data out, channel 2
14	OUT ₁	Data out, channel 1
15	GND ₂	Ground return for V _{DD2} (pin 15 internally connected to pin 9)
16	V _{DD2}	Supply voltage



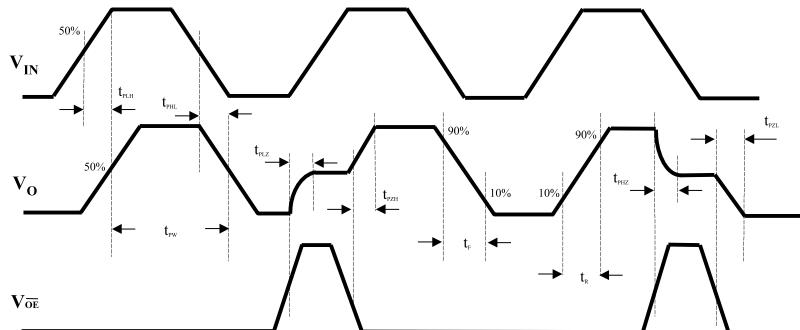
IL817-3/IL817

IL821 Pin Connections

1	GND ₁	Ground return for V _{DD1} (pins 1, 2, 7, and 8 internally connected)
2	V _{DD1}	Supply voltage
3	OUT ₁	Data out, channel 1
4	IN ₂	Data in, channel 2
5	NC	No connection
6	GND ₁	Ground return for V _{DD1} (pins 1, 2, 7, and 8 internally connected)
7	GND ₂	Ground return for V _{DD2} (pins 9, 10, 15, and 16 internally connected)
8	V _{DD2}	Supply voltage
9	OUT ₂	Data out, channel 2
10	IN ₁	Data in, channel 1
11	NC	No connection
12	IN ₂	Data in, channel 2
13	OUT ₁	Data out, channel 1
14	NC	No connection
15	GND ₂	Ground return for V _{DD2} (pins 9, 10, 15, and 16 internally connected)
16	GND ₁	Ground return for V _{DD1} (pins 1, 2, 7, and 8 internally connected)


IL821

Timing Diagrams



Legend

t_{PLH}	Propagation Delay, Low to High
t_{PHL}	Propagation Delay, High to Low
t_{PW}	Minimum Pulse Width
t_{PLZ}	Propagation Delay, Low to High Impedance
t_{PZH}	Propagation Delay, High Impedance to High
t_{PHZ}	Propagation Delay, High to High Impedance
t_{PZL}	Propagation Delay, High Impedance to Low
t_R	Rise Time
t_F	Fall Time

Truth Tables

Output Enable

V_I	V_{OE}	V_O
L	L	L
H	L	H
L	H	Z
H	H	Z

SYNC

SYNC	Internal Refresh Clock
0	Enabled
1	Disabled

Note: SYNC should be left open or connected to GND to enable the internal refresh clock, or connected to V_{DD} to disable the internal clock.

3.3 Volt Electrical Specifications (T_{min} to T_{max} unless otherwise stated)						
Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Input Quiescent Supply Current						
IL810, IL811, IL815	I_{DD1}		15	30	μA	
IL812, IL814, IL817, IL821			1.3	1.8	mA	
IL816			2.6	3.6	mA	
Output Quiescent Supply Current						
IL810, IL812, IL821	I_{DD2}		1.3	1.8	mA	
IL811, IL814, IL816			2.6	3.6	mA	
IL815			5.2	7.2	mA	
IL817			3.9	5.4	mA	
Logic Input Current	I_I	-10		10	μA	
Logic High Output Voltage	V_{OH}	$V_{DD} - 0.1$	V_{DD}		V	$I_O = -20 \mu A, V_I = V_{IH}$
		0.8 x V_{DD}	0.9 x V_{DD}			$I_O = -4 mA, V_I = V_{IH}$
Logic Low Output Voltage	V_{OL}		0	0.1	V	$I_O = 20 \mu A, V_I = V_{IL}$
			0.5	0.8		$I_O = 4 mA, V_I = V_{IL}$

Switching Specifications ($V_{DD} = 3.3$ V)						
Maximum Data Rate		100	110		Mbps	$C_L = 15 pF$
Pulse Width ⁽⁷⁾	PW	10			ns	V_O 50% points;
Propagation Delay Input to Output (High to Low)	t_{PHL}		12	18	ns	$C_L = 15 pF$
Propagation Delay Input to Output (Low to High)	t_{PLH}		12	18	ns	$C_L = 15 pF$
Propagation Delay Enable to Output (High to High Impedance)	t_{PHZ}			5	ns	$C_L = 15 pF$
Propagation Delay Enable to Output (Low to High Impedance)	t_{PLZ}			5	ns	$C_L = 15 pF$
Propagation Delay Enable to Output (High Impedance to High)	t_{PZH}			5	ns	$C_L = 15 pF$
Propagation Delay Enable to Output (High Impedance to Low)	t_{PZL}			5	ns	$C_L = 15 pF$
Pulse Width Distortion ⁽²⁾	PWD		2	3	ns	$C_L = 15 pF$
Propagation Delay Skew ⁽³⁾	t_{PSK}		4	6	ns	$C_L = 15 pF$
Output Rise Time (10%–90%)	t_R		2	4	ns	$C_L = 15 pF$
Output Fall Time (10%–90%)	t_F		2	4	ns	$C_L = 15 pF$
Common Mode Transient Immunity (Output Logic High or Logic Low) ⁽⁴⁾	$ CM_H , CM_L $	30	50		kV/ μs	$V_{CM} = 1500 V_{DC}$ $t_{TRANSIENT} = 25 ns$
Channel-to-Channel Skew	t_{CSK}		2	3	ns	$C_L = 15 pF$
SYNC Internal Clock Off Time ⁽¹¹⁾	t_{OFF}			5	ns	
Dynamic Power Consumption ⁽⁶⁾			140	240	$\mu A/\text{Mbps}$	per channel

Magnetic Field Immunity ⁽⁸⁾ ($V_{DD2} = 3$ V, $3V < V_{DD1} < 5.5$ V)						
Power Frequency Magnetic Immunity	H_{PF}	1000	1500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H_{PM}	1800	2000		A/m	$t_p = 8 \mu s$
Damped Oscillatory Magnetic Field	H_{OSC}	1800	2000		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier ⁽⁹⁾	K_X		2.5			

5 Volt Electrical Specifications (T _{min} to T _{max} unless otherwise stated)						
Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Input Quiescent Supply Current						
IL810, IL811, IL815	I _{DD1}		24	40	μA	
IL814, IL817, IL821			1.8	2.5	mA	
IL816			3.6	5	mA	
Output Quiescent Supply Current						
IL810, IL821	I _{DD2}		1.8	2.5	mA	
IL811, IL814, IL816			3.6	5	mA	
IL815			7.2	10	mA	
IL817			5.4	7.5	mA	
Logic Input Current	I _I	-10		10	μA	
Logic High Output Voltage	V _{OH}	V _{DD} - 0.1 0.8 x V _{DD}	V _{DD} 0.9 x V _{DD}		V	I _O = -20 μA, V _I = V _{IH} I _O = -4 mA, V _I = V _{IH}
Logic Low Output Voltage	V _{OL}		0 0.5	0.1 0.8	V	I _O = 20 μA, V _I = V _{IL} I _O = 4 mA, V _I = V _{IL}

Switching Specifications						
Maximum Data Rate		100	110		Mbps	C _L = 15 pF
Pulse Width ⁽⁷⁾	PW	10			ns	V _O 50% points
Propagation Delay Input to Output (High to Low)	t _{PHL}		10	15	ns	C _L = 15 pF
Propagation Delay Input to Output (Low to High)	t _{PLH}		10	15	ns	C _L = 15 pF
Propagation Delay Enable to Output (High to High Impedance)	t _{PHZ}			5	ns	C _L = 15 pF
Propagation Delay Enable to Output (Low to High Impedance)	t _{PLZ}			5	ns	C _L = 15 pF
Propagation Delay Enable to Output (High Impedance to High)	t _{PZH}			5	ns	C _L = 15 pF
Propagation Delay Enable to Output (High Impedance to Low)	t _{PZL}			5	ns	C _L = 15 pF
Pulse Width Distortion ⁽²⁾	PWD		2	3	ns	C _L = 15 pF
Propagation Delay Skew ⁽³⁾	t _{PSK}		4	6	ns	C _L = 15 pF
Output Rise Time (10%–90%)	t _R		1	3	ns	C _L = 15 pF
Output Fall Time (10%–90%)	t _F		1	3	ns	C _L = 15 pF
Common Mode Transient Immunity (Output Logic High or Logic Low) ⁽⁴⁾	CM _H , CM _L	30	50		kV/μs	V _{CM} = 1500 V _{DC} t _{TRANSIENT} = 25 ns
Channel-to-Channel Skew	t _{CSK}		3	5	ns	C _L = 15 pF
SYNC Internal Clock Off Time ⁽¹¹⁾	t _{OFF}			5	ns	
Dynamic Power Consumption ⁽⁶⁾			200	340	μA/Mbps	per channel

Magnetic Field Immunity ⁽⁸⁾ (V _{DD2} = 5V, 3V < V _{DD1} < 5.5V)						
Power Frequency Magnetic Immunity	H _{PF}	2,800	3,500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H _{PM}	4,000	4,500		A/m	t _p = 8 μs
Damped Oscillatory Magnetic Field	H _{OSC}	4,000	4,500		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier ⁽⁹⁾	K _X		2.5			



IL800-Series Isolators

Notes (apply to both 3.3 V and 5 V specifications):

1. Absolute maximum means the device will not be damaged if operated under these conditions. It does not guarantee performance.
2. PWD is defined as $|t_{PHL} - t_{PLH}|$. %PWD is equal to PWD divided by pulse width.
3. t_{PSK} is the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} between devices at 25°C.
4. CM_H is the maximum common mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DD2}$. CM_L is the maximum common mode input voltage that can be sustained while maintaining $V_O < 0.8 V$. The common mode voltage slew rates apply to both rising and falling common mode voltage edges.
5. Device is considered a two terminal device: pins on each side of the package are shorted.
6. Dynamic power consumption is calculated per channel and is supplied by the channel's input side power supply.
7. Minimum pulse width is the minimum value at which specified PWD is guaranteed.
8. The relevant test and measurement methods are given in the Electromagnetic Compatibility section on p. 9.
9. External magnetic field immunity is improved by this factor if the field direction is "end-to-end" rather than to "pin-to-pin" (see diagram on p. 9).
10. If internal clock is used, devices will respond to DC states on inputs within a maximum of 9 μs . Outputs may oscillate if the SYNC input slew rate is less than 1 V/ms.
11. t_{off} is the maximum time for the internal refresh clock to shut down.

Application Information

Electrostatic Discharge Sensitivity

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.

Electromagnetic Compatibility

IsoLoop Isolators have the lowest EMC footprint of any isolation technology. IsoLoop Isolators' Wheatstone bridge configuration and differential magnetic field signaling ensure excellent EMC performance against all relevant standards.

Additionally, on the IL810 and IL815, the internal clock can be disabled for even better EMC performance.

These isolators are fully compliant with generic EMC standards EN50081, EN50082-1 and the umbrella line-voltage standard for Information Technology Equipment (ITE) EN61000. NVE has completed compliance tests in the categories below:

EN50081-1

Residential, Commercial & Light Industrial

Methods EN55022, EN55014

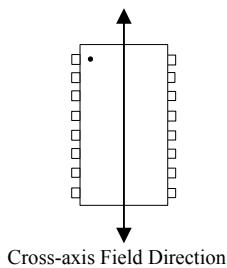
EN50082-2: Industrial Environment

Methods EN61000-4-2 (ESD), EN61000-4-3 (Electromagnetic Field Immunity), EN61000-4-4 (Electrical Transient Immunity), EN61000-4-6 (RFI Immunity), EN61000-4-8 (Power Frequency Magnetic Field Immunity), EN61000-4-9 (Pulsed Magnetic Field), EN61000-4-10 (Damped Oscillatory Magnetic Field)

ENV50204

Radiated Field from Digital Telephones (Immunity Test)

Immunity to external magnetic fields is even higher if the field direction is "end-to-end" rather than to "pin-to-pin" as shown in the diagram below:



Power Supply Decoupling

Both power supplies to these devices should be decoupled with low ESR ceramic capacitors of at least 47 nF. Capacitors must be located as close as possible to the V_{DD} pins.

Maintaining Creepage

Creepage distances are often critical in isolated circuits. In addition to meeting JEDEC standards, NVE isolator packages have unique creepage specifications. Standard pad libraries often extend under the package, compromising creepage and clearance. Similarly, ground planes, if used, should be spaced to avoid compromising clearance. Package drawings and recommended pad layouts are included in this datasheet.

Dynamic Power Consumption

IsoLoop Isolators achieve their low power consumption from the way they transmit data across the isolation barrier. A magnetic field is created around the GMR Wheatstone bridge by detecting the edge transitions of the input logic signal and converting them to narrow current pulses. Depending on the direction of the magnetic field, the bridge causes the output comparator to switch following the input logic signal. Since the current pulses are narrow, about 2.5 ns, the power consumption is independent of mark-to-space ratio and solely dependent on frequency. This has obvious advantages over optocouplers, which have power consumption heavily dependent on mark-to-space ratio.

DC Correctness, EMC, and the SYNC Function

NVE digital isolators have the lowest EMC noise signature of any high-speed digital isolator on the market today because of the dc nature of the GMR sensors used. It is perhaps fair to include optocouplers in that dc category too, but their limited parametric performance, physically large size, and wear-out problems effectively limit side by side comparisons between NVE's isolators and isolators coupled with RF, matched capacitors, or transformers.

IL800-Series isolators has an internal refresh clock which ensure the synchronization of input and output within 9 μ s of the supply passing the 1.5 V threshold. The IL810 and IL815 allow external control of the refresh clock through the SYNC pin thereby further lowering the EMC footprint. This can be advantageous in applications such as hi-fi, motor control and power conversion.

The isolators can be used with Power on Reset (POR) circuits common in microcontroller applications, as the means of ensuring the output of the device is in the same state as the input a short time after power up. Figure 1 shows a practical Power on Reset circuit:

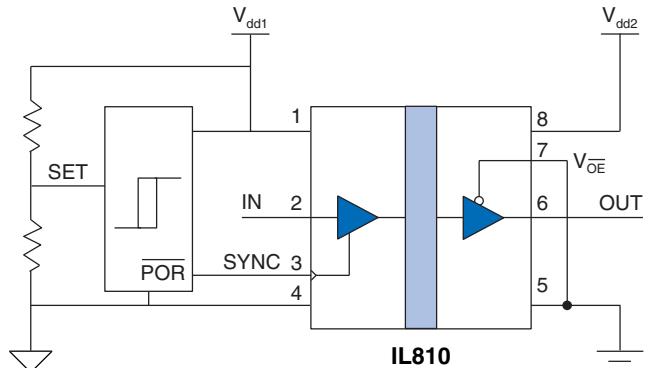
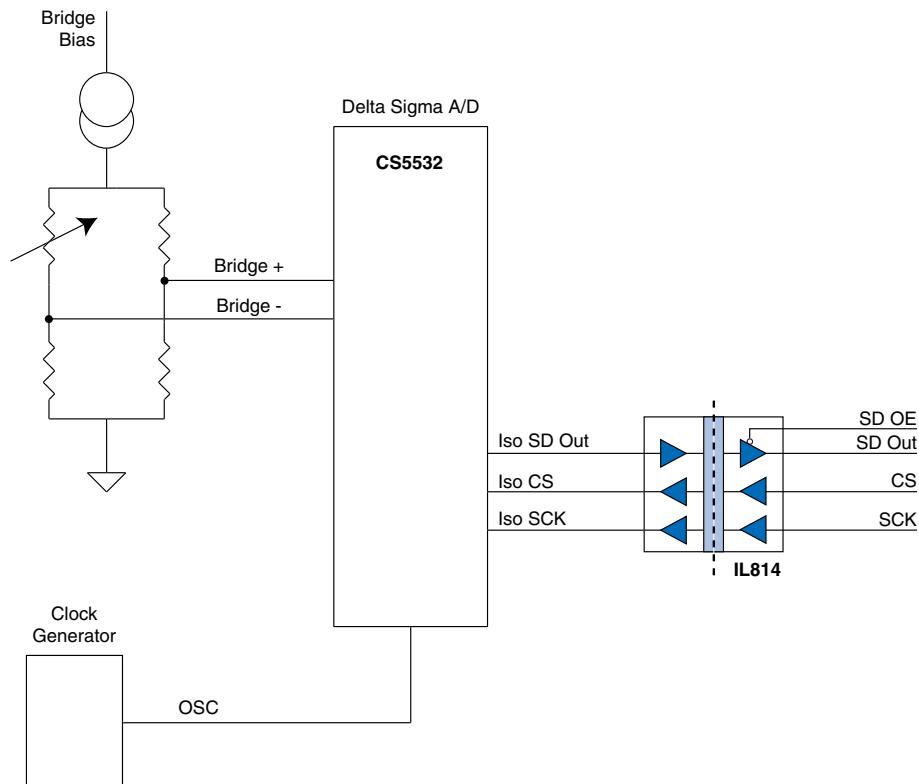


Fig. 1. Typical Power On Reset Circuit for IL810

After POR, the SYNC line goes high, the internal clock is disabled, and the EMC signature is optimized. Decoupling capacitors are omitted for clarity.

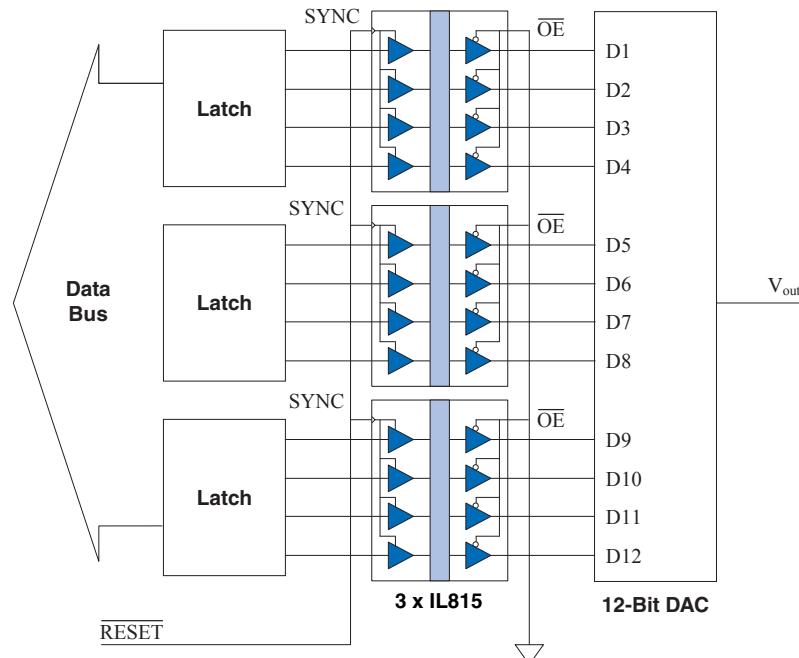
Illustrative Applications

Isolated A/D Converter



A delta-sigma A-D converter interfaced with the three-channel IL814. Multiple channels can easily be combined using the IL814's output enable function.

12-Bit D/A Converter Isolation

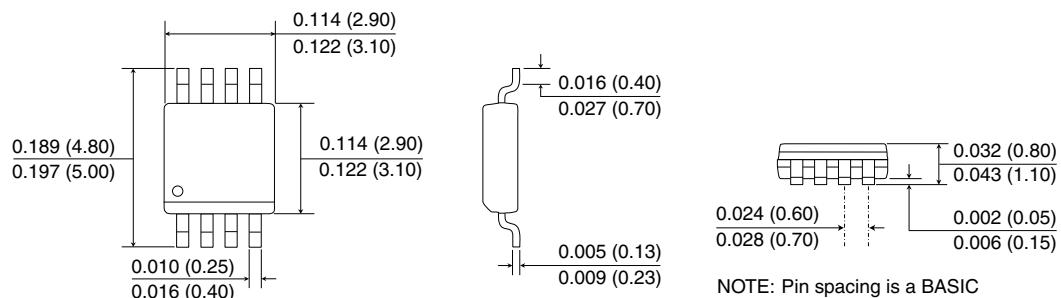


The IL815 four-channel isolator is ideally suited for parallel bus isolation. The circuit above uses three IL815s to isolate a 12-bit DAC. The SYNC function automatically synchronizes the outputs to the inputs, ensuring correct data on the isolator outputs. After the reset pulse goes high, data transfer from input to output is initiated by the leading edge of each changing data bit.

Package Drawings

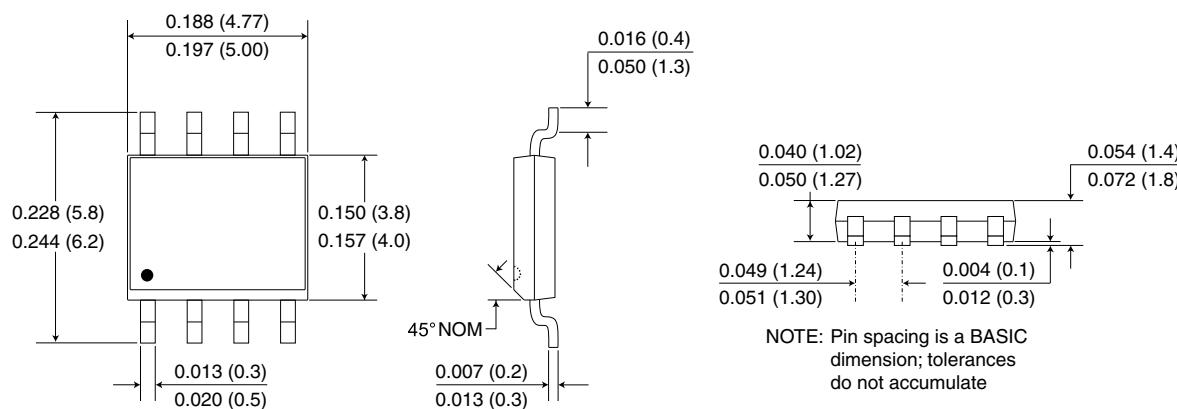
8-pin MSOP (-1 suffix; 1 and 2 channel)

Dimensions in inches (mm); scale = approx. 5X



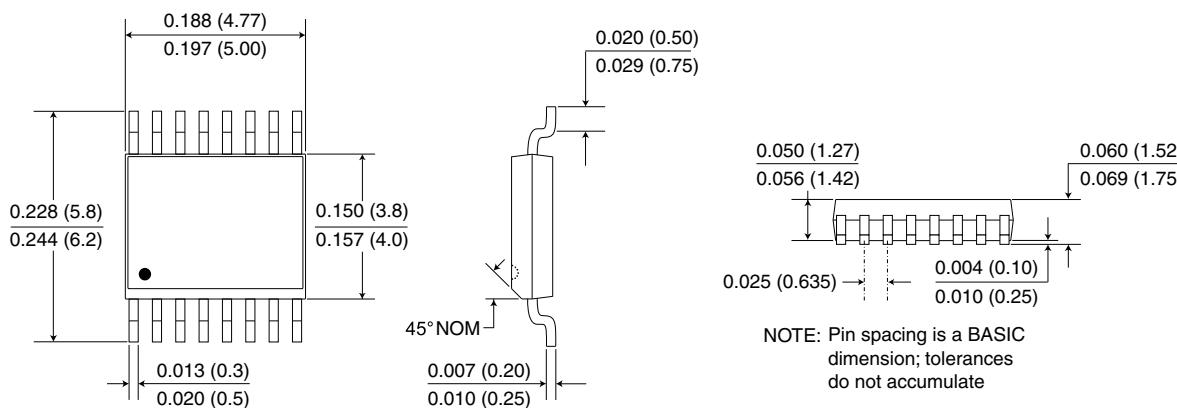
8-pin SOIC Package (-3 suffix; 1 and 2 channel)

Dimensions in inches (mm); scale = approx. 5X



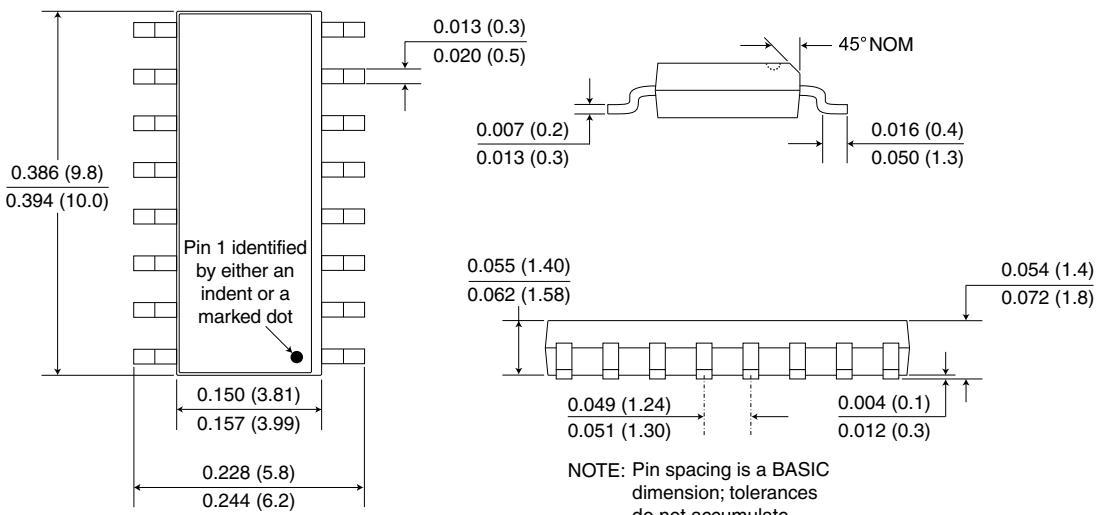
Ultraminiature 16-pin QSOP Package (-1 suffix; 3 and 4 channel)

Dimensions in inches (mm); scale = approx. 5X



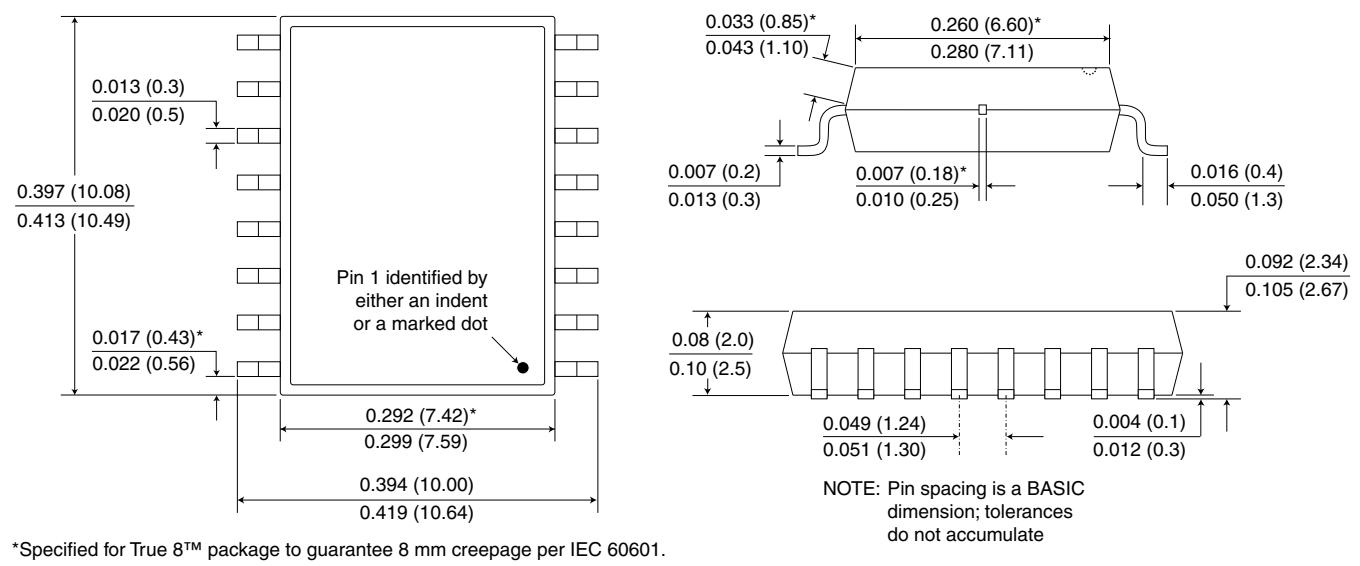
0.15" 16-pin SOIC Package (-3 suffix; 3 and 4 channel)

Dimensions in inches (mm); scale = approx. 5X



True8™ 0.3" 16-pin SOIC Package (no suffix; 2, 3, and 4 channel)

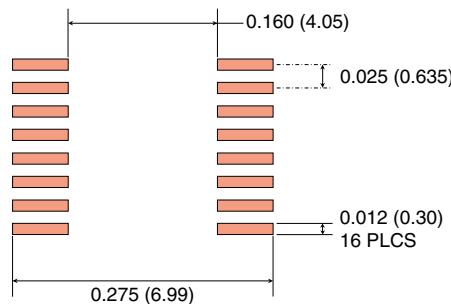
Dimensions in inches (mm); scale = approx. 5X



Recommended Pad Layouts

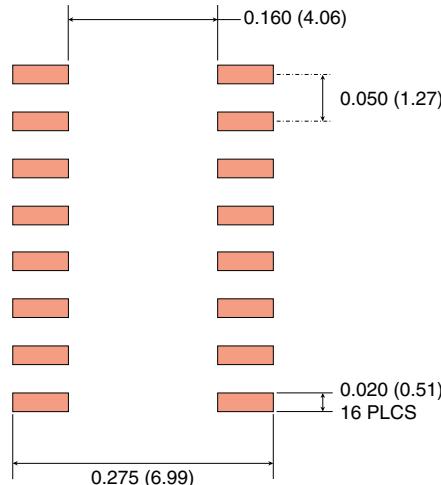
4 mm x 5 mm 16-pin QSOP Pad Layout

Dimensions in inches (mm); scale = approx. 5X



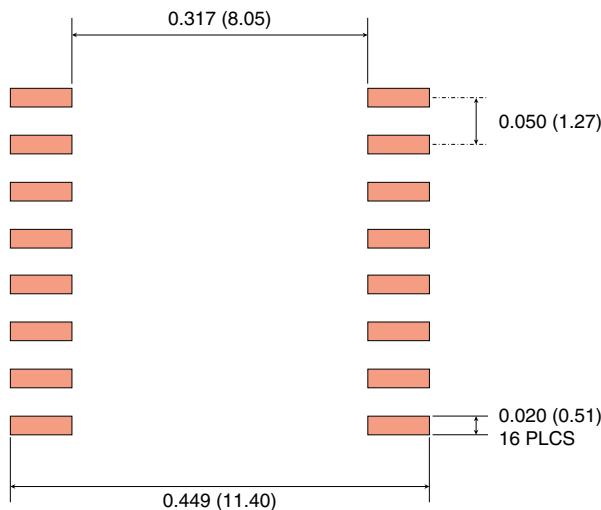
0.15" 16-pin SOIC Pad Layout

Dimensions in inches (mm); scale = approx. 5X



0.3" 16-pin SOIC Pad Layout

Dimensions in inches (mm); scale = approx. 5X



Ordering Information
IL 8 16 - 3 T E TR13

- **Bulk Packaging**
Blank = Tube
TR7 = 7" Tape and Reel
TR13 = 13" Tape and Reel
- **Package**
E = RoHS Compliant
- **Temperature Range**
T = -40°C to 125°C
- **Package Type**
-1 = 8-pin MSOP or 16-pin QSOP
-3 = 0.15" 8-pin or 16-pin SOIC
Blank = True8™ 0.3" 16-pin SOIC
- **Channels**
10 = 1 Transmit Channel
11 = 2 Transmit Channels
21 = 1 Transmit Channel
1 Receive Channel
14 = 2 Transmit Channels;
1 Receive Channel
15 = 4 Transmit Channels
16 = 2 Transmit Channels;
2 Receive Channels
17 = 3 Transmit Channels;
1 Receive Channels
- **Base Part Number**
8 = 110 Mbps, DC-Correct
- **Product Family**
IL = Isolators

Available Parts	Xmit Ch.	Rev. Ch.	Package
IL810T-1E	1	0	MSOP-8
IL810T-3E	1	0	SOIC-8
IL811T-1E	2	0	MSOP-8
IL811T-3E	2	0	SOIC-8
IL814T-1E	2	1	QSOP-16
IL814T-3E	2	1	0.15" SOIC-16
IL814TE	2	1	True8
IL815T-1E	4	0	QSOP-16
IL815T-3E	4	0	0.15" SOIC-16
IL815TE	4	0	True8
IL816T-1E	2	2	QSOP
IL816T-3E	2	2	0.15" SOIC-16
IL816TE	2	2	True8
IL817T-3E	3	1	0.15" SOIC-16
IL817TE	3	1	True8
IL821T-3E	1	1	SOIC-8
IL821TE	1	1	True8

ISB-DS-001-IL800-F**June 2014****Changes:**

- Added IL814T-1, IL815T-1, and IL816T-1 QSOP versions.
- Dropped IL812 configuration in favor of IL821 two-channel bidirectional configuration.
- Updated thermal characteristics.
- Added recommended pad layouts.

ISB-DS-001-IL800-E**November 2013****Changes:**

- Added IL821TE part type (16-pin True8 wide-body package).
- Added output enables to IL816 and IL817.
- Clarified pinouts for different package types.
- IEC 60747-5-5 (VDE 0884) certification.
- Upgraded from MSL 2 to MSL 1.

ISB-DS-001-IL800-D**August 2013****Changes:**

- Tighter quiescent current specifications.
- Added IL817 part types.

ISB-DS-001-IL800-C**July 2013****Changes:**

- Added IL812-3 and IL821-3 part types (8-pin SOIC packages).

ISB-DS-001-IL800-B**June 2013****Changes:**

- Increased transient immunity specifications based on additional data.

ISB-DS-001-IL800-A**May 27, 2013****Changes:**

- Added "T" to full part numbers to indicate 125°C max. operating temperature.
- Added two-channel bidirectional versions (IL812 and IL821).
- Added list of available part types.

ISB-DS-001-IL800-PREVIEW**May 3, 2013****Changes:**

- Released product preview.

Datasheet Limitations

The information and data provided in datasheets shall define the specification of the product as agreed between NVE and its customer, unless NVE and customer have explicitly agreed otherwise in writing. All specifications are based on NVE test protocols. In no event however, shall an agreement be valid in which the NVE product is deemed to offer functions and qualities beyond those described in the datasheet.

Limited Warranty and Liability

Information in this document is believed to be accurate and reliable. However, NVE does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NVE be liable for any indirect, incidental, punitive, special or consequential damages (including, without limitation, lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Right to Make Changes

NVE reserves the right to make changes to information published in this document including, without limitation, specifications and product descriptions at any time and without notice. This document supersedes and replaces all information supplied prior to its publication.

Use in Life-Critical or Safety-Critical Applications

Unless NVE and a customer explicitly agree otherwise in writing, NVE products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical devices or equipment. NVE accepts no liability for inclusion or use of NVE products in such applications and such inclusion or use is at the customer's own risk. Should the customer use NVE products for such application whether authorized by NVE or not, the customer shall indemnify and hold NVE harmless against all claims and damages.

Applications

Applications described in this datasheet are illustrative only. NVE makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NVE products, and NVE accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NVE product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customers. Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NVE does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customers. The customer is responsible for all necessary testing for the customer's applications and products using NVE products in order to avoid a default of the applications and the products or of the application or use by customer's third party customers. NVE accepts no liability in this respect.

Limiting Values

Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the recommended operating conditions of the datasheet is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and Conditions of Sale

In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NVE hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NVE products by customer.

No Offer to Sell or License

Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export Control

This document as well as the items described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

Automotive Qualified Products

Unless the datasheet expressly states that a specific NVE product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NVE accepts no liability for inclusion or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NVE's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NVE's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NVE for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NVE's standard warranty and NVE's product specifications.



IL800-Series Isolators

An ISO 9001 Certified Company

NVE Corporation
11409 Valley View Road
Eden Prairie, MN 55344-3617 USA
Telephone: (952) 829-9217
Fax: (952) 829-9189
www.nve.com
e-mail: iso-info@nve.com

©NVE Corporation
All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

ISB-DS-001-IL800T-F

June 2014